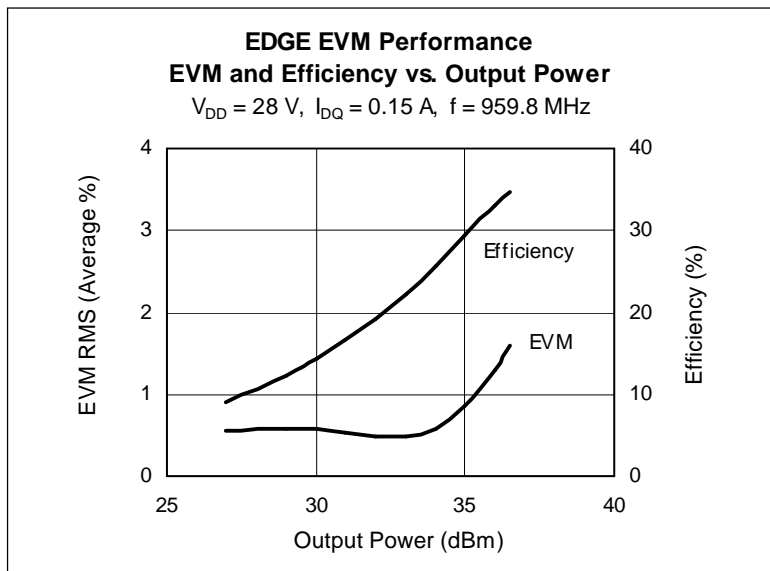


## LDMOS RF Power Field Effect Transistor 10 W, 860–960 MHz

### Description

The PTF080101 is a 10 W, internally matched *GOLDMOS* FET intended for EDGE applications in the 860 to 960 MHz band. Full gold metallization ensures excellent device lifetime and reliability.



### Features

- Broadband internal matching
- Typical EDGE performance
  - Average output power = 4.0 W
  - Gain = 19 dB
  - Efficiency = 31%
- Typical CW performance
  - Output power at P-1dB = 13 W
  - Gain = 18 dB
  - Efficiency = 55%
- Integrated ESD protection: Human Body Model, Class 1 (minimum)
- Excellent thermal stability
- Low HCI drift
- Capable of handling 10:1 VSWR @ 28 V, 10 W (CW) output power



PTF080101S  
Package 32259

**ESD:** Electrostatic discharge sensitive device—observe handling precautions!

**RF Characteristics** at  $T_{CASE} = 25^{\circ}\text{C}$  unless otherwise indicated

**EDGE Measurements** (not subject to production test—verified by design/characterization in Infineon test fixture)

$V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 150\text{ mA}$ ,  $P_{OUT} = 4.0\text{ W}$ ,  $f = 959.8\text{ MHz}$

Characteristic	Symbol	Min	Typ	Max	Units
Error Vector Magnitude	EVM (RMS)	—	1.3	—	%
Modulation Spectrum @ 400 kHz	ACPR	—	-61	—	dBc
Modulation Spectrum @ 600 kHz	ACPR	—	-75	—	dBc
Gain	$G_{ps}$	—	19	—	dB
Drain Efficiency	$\eta_D$	—	31	—	%

**Two-Tone Measurements** (tested in Infineon test fixture)

$V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 150\text{ mA}$ ,  $P_{OUT} = 10\text{ W PEP}$ ,  $f = 960\text{ MHz}$ , tone spacing = 1 MHz

Characteristic	Symbol	Min	Typ	Max	Units
Gain	$G_{ps}$	—	19	—	dB
Drain Efficiency	$\eta_D$	—	37	—	%
Intermodulation Distortion	IMD	—	-32	—	dBc

**DC Characteristics** at  $T_{CASE} = 25^{\circ}C$  unless otherwise indicated

Characteristic	Conditions	Symbol	Min	Typ	Max	Units
Drain–Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_{DS} = 10\ \mu\text{A}$	$V_{(BR)DSS}$	65	—	—	V
Drain Leakage Current	$V_{DS} = 28\text{ V}, V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	1.0	$\mu\text{A}$
On–State Resistance	$V_{GS} = 10\text{ V}, I_{DS} = 0.1\text{ A}$	$R_{DS(on)}$	—	0.83	—	$\Omega$
Operating Gate Voltage	$V_{DS} = 28\text{ V}, I_{DQ} = 150\text{ mA}$	$V_{GS}$	—	3.2	—	V
Gate Leakage Current	$V_{GS} = 10\text{ V}, V_{DS} = 0\text{ V}$	$I_{GSS}$	—	—	1.0	$\mu\text{A}$

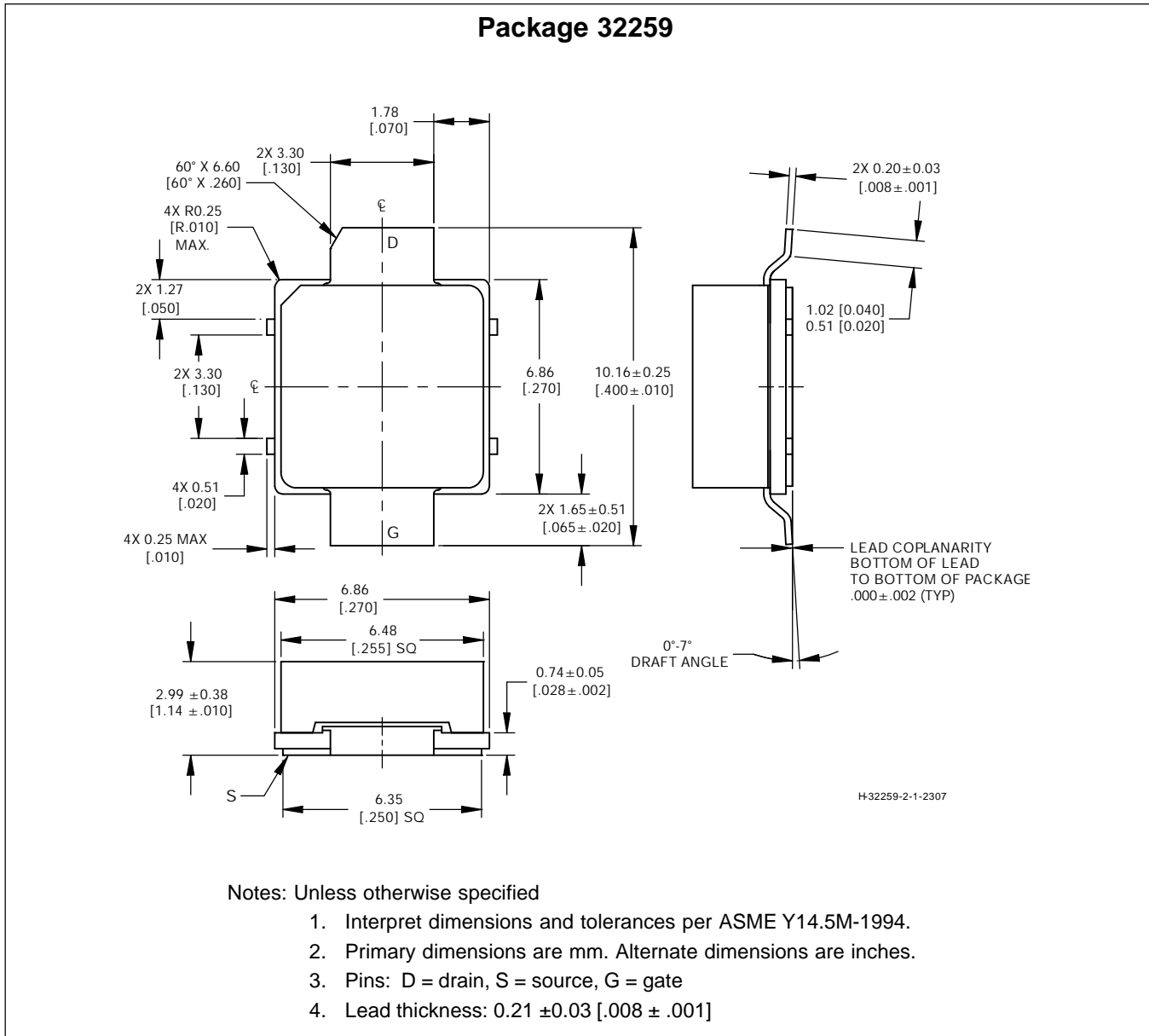
**Maximum Ratings**

Parameter	Symbol	Value	Unit
Drain–Source Voltage	$V_{DSS}$	65	V
Gate–Source Voltage	$V_{GS}$	–0.5 to +12	V
Operating Junction Temperature	$T_J$	200	$^{\circ}C$
Total Device Dissipation	$P_D$	58	W
Above $25^{\circ}C$ derate by		0.333	$W/^{\circ}C$
Storage Temperature Range	$T_{STG}$	–40 to +150	$^{\circ}C$
Thermal Resistance ( $T_{CASE} = 70^{\circ}C$ )	$R_{\theta JC}$	3.0	$^{\circ}C/W$

### Ordering Information

Type	Package Outline	Package Description	Marking
PTF080101S	32259	Thermally enhanced, surface mount	PTF080101S

### Package Outline Specifications



Find the latest and most complete information about products and packaging at the Infineon Internet page  
<http://www.infineon.com/products>

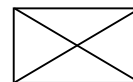
Page	Subjects (major changes since last revision)

**We Listen to Your Comments**

Any information within this document that you feel is wrong, unclear or missing at all?  
Your feedback will help us to continuously improve the quality of this document.  
Please send your proposal (including a reference to this document) to:

[highpowerRF@infineon.com](mailto:highpowerRF@infineon.com)

To request other information, contact us at:  
+1 877 465 3667 (1-877-GOLDMOS) USA  
or +1 408 776 0600 International



GOLDMOS® is a registered trademark of Infineon Technologies AG.

**Edition 2004-03-08**

**Published by Infineon Technologies AG,  
St.-Martin-Strasse 53,  
81669 München, Germany**

**© Infineon Technologies AG 2004.  
All Rights Reserved.**

**Attention please!**

The information herein is given to describe certain components and shall not be considered as a guarantee of characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

**Information**

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office ([www.infineon.com/rfpower](http://www.infineon.com/rfpower)).

**Warnings**

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.